

FIG. 1

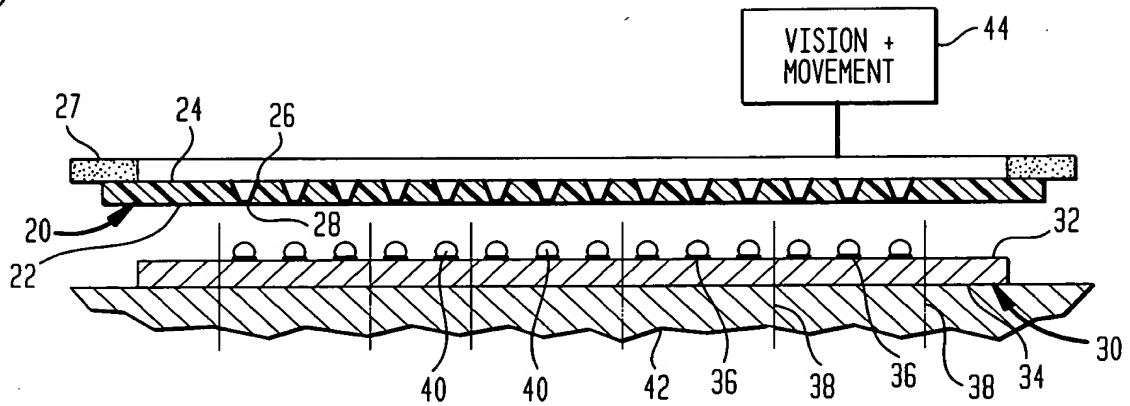


FIG. 2

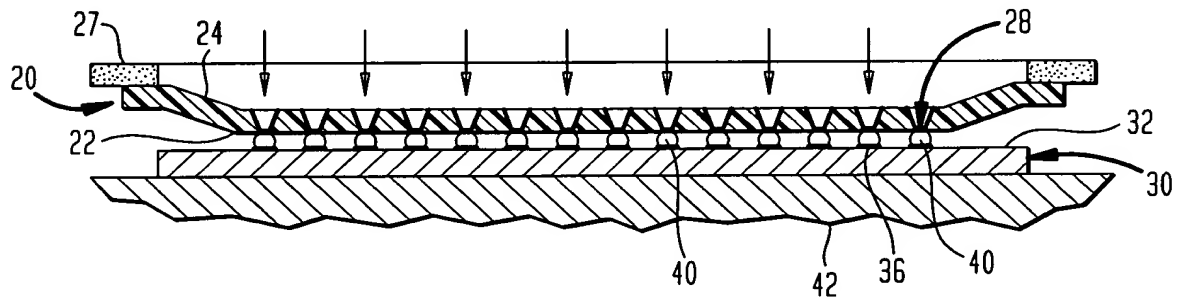


FIG. 3

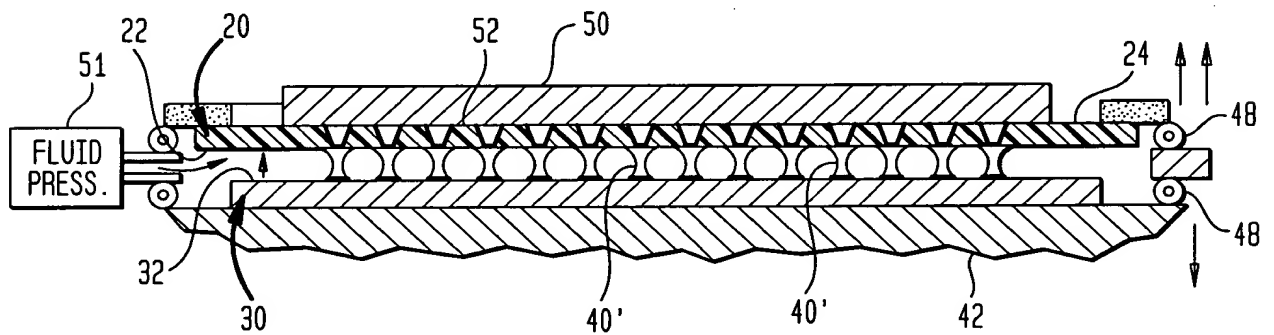
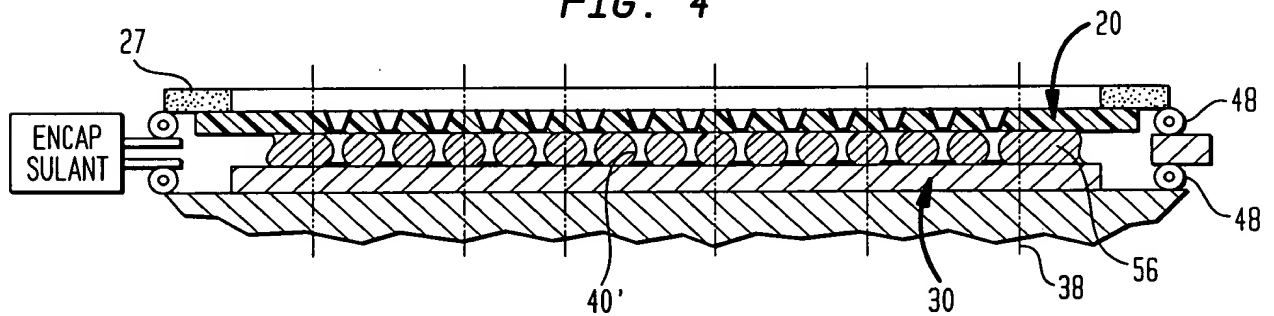


FIG. 4



This diagram shows a cross-sectional view of a second embodiment of the device. It features a substrate 26 with a top surface 20' and a bottom surface 30'. A layer 40' is disposed on the top surface 20'. A layer 56' is disposed on the bottom surface 30'. A layer 58 is disposed on the top surface 20' and the layer 40'. The layer 58 has a top surface 58 and a bottom surface 56'.

This diagram shows a cross-sectional view of a second embodiment of the device. It features a stack of layers, with layer 30' on top of layer 40'. Inside layer 30', there are three circular structures labeled 20'. Below these, within layer 40', are three conical structures labeled 26. The entire assembly is mounted on a base 60. The base has a top surface 62 and a bottom surface 64. On the left side of the base, there are two vertical structures labeled 56'.

This diagram shows a cross-sectional view of a second embodiment of the device. It features a substrate 120 with a top surface 122 and a bottom surface 126. A layer 127 is disposed on the top surface 122. A layer 128 is disposed on the bottom surface 126. A layer 130 is disposed on the bottom surface 126, and a layer 132 is disposed on the top surface 122. A layer 136 is disposed on the bottom surface 126, and a layer 140 is disposed on the top surface 122.

FIG. 10

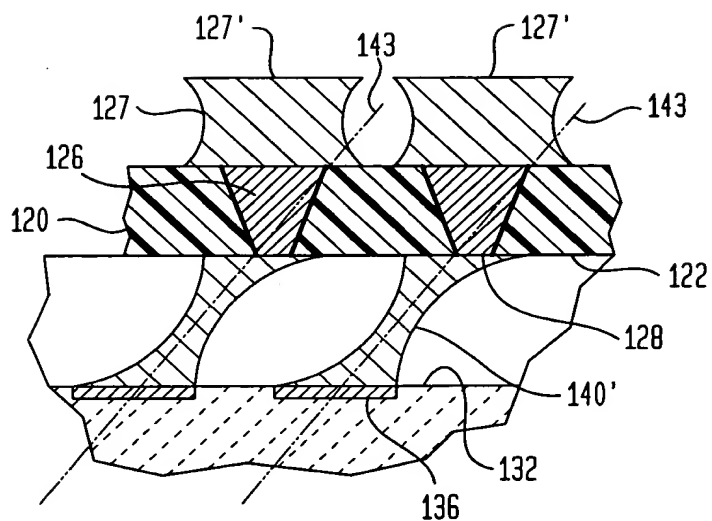


FIG. 11

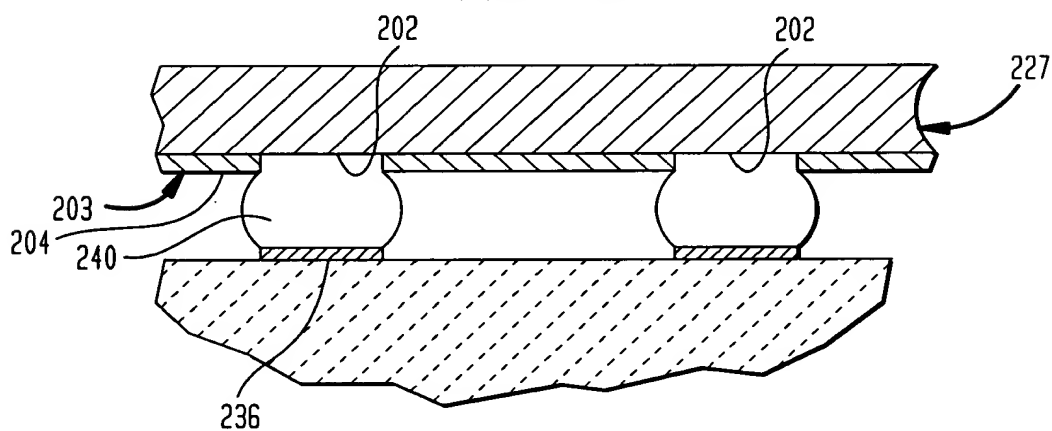


FIG. 12

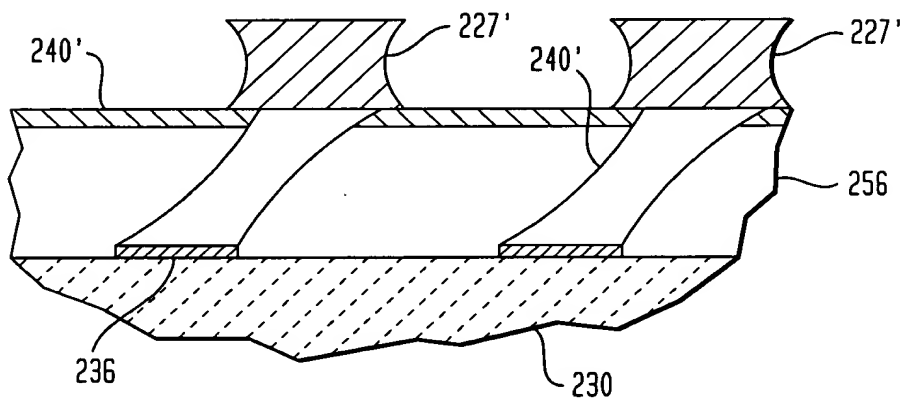


FIG. 13

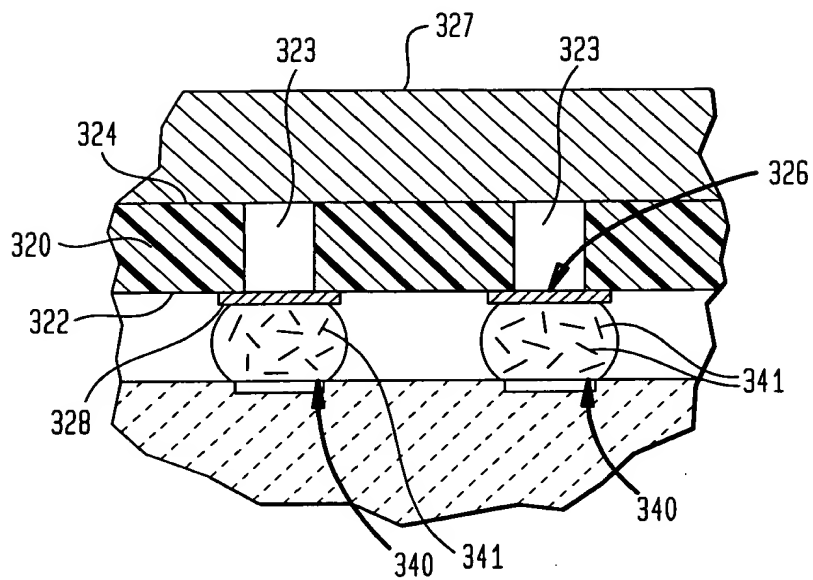
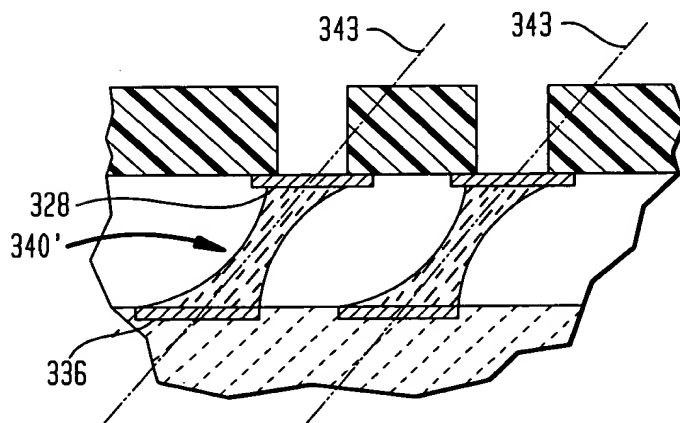


FIG. 14







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FIG. 10

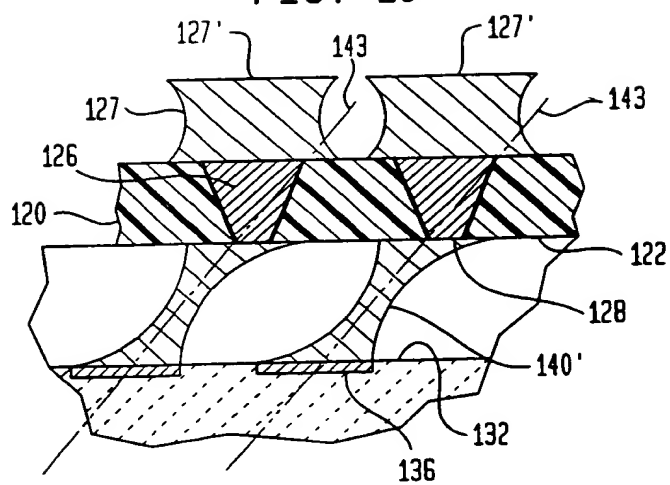


FIG. 11

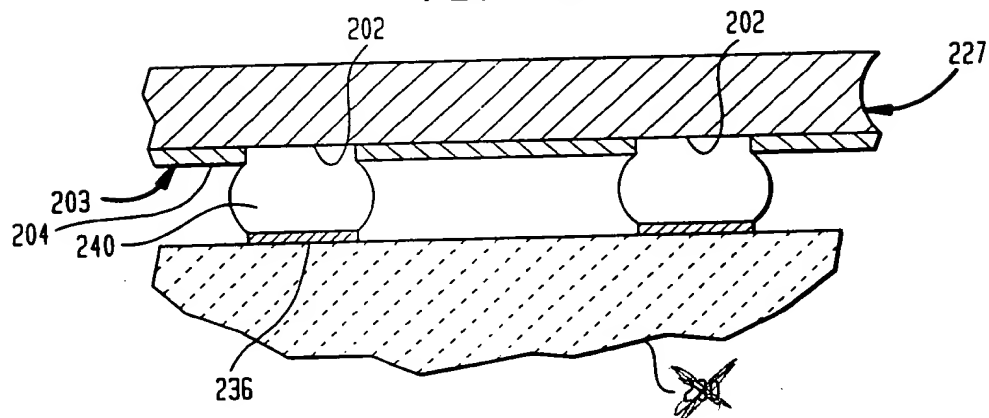
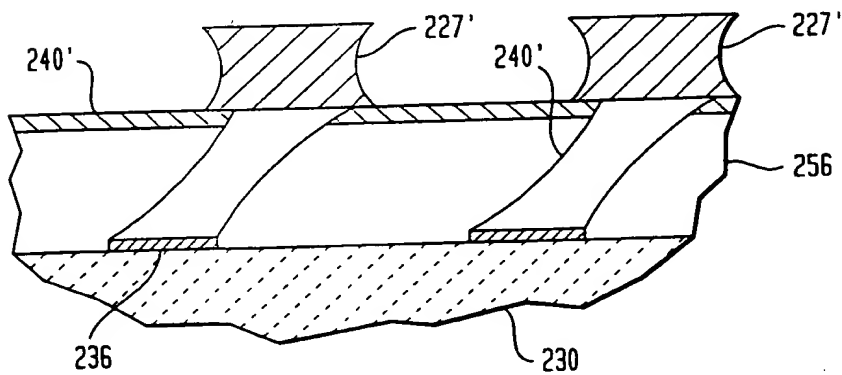


FIG. 12





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FIG. 13

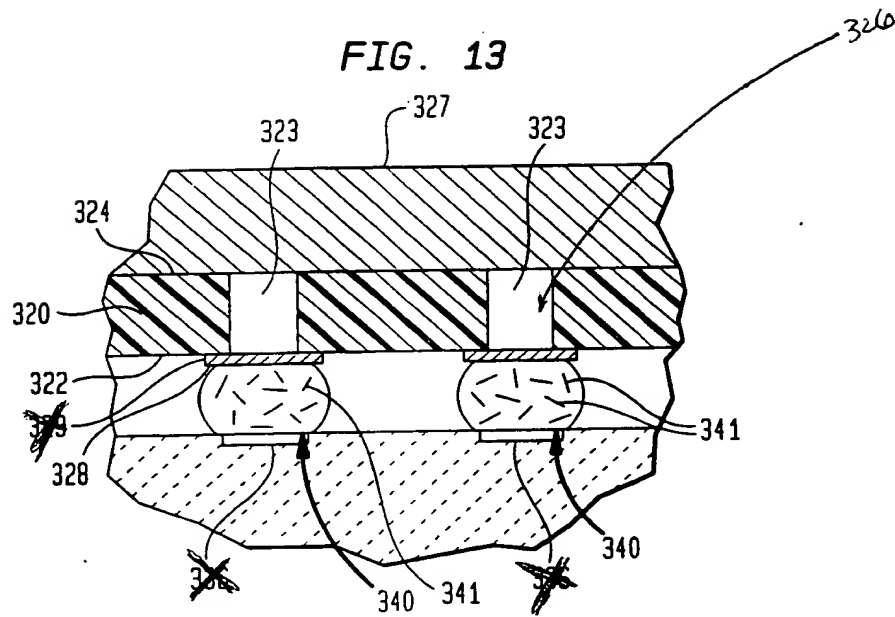


FIG. 14

